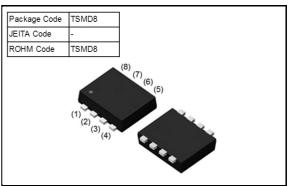


# Schottky Barrier Diode

V <sub>R</sub>	30	V
l <sub>o</sub>	2	А
l <sub>FSM</sub>	8	Α

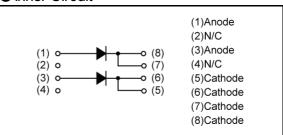
## Outline



#### Features

High reliability Small power mold type Super low V<sub>F</sub>

## Inner Circuit



# Application

General rectification

■ Packaging Specifications

T ackaging openications					
Packing	Embossed Tape				
Reel Size(mm)	180				
Taping Width(mm)	8				
Basic Ordering Unit(pcs)	3000				
Taping Code	TR				
Marking	613				

# Structure

Silicon epitaxial planar

● Absolute Maximum Ratings (T<sub>a</sub>=25°C unless otherwise specified)

O · u		• •		
Parameter	Symbol	Conditions	Limits	Unit
Repetitive peak reverse voltage	V <sub>RM</sub>	Duty≦0.5	30	V
Reverse voltage	V <sub>R</sub>	Reverse direct voltage	30	V
Average rectified forward current	lo	Glass epoxy mounted, 60Hz half sin waveform, resistive load, per dlode	2	А
Peak forward surge current	I <sub>FSM</sub>	60Hz half sin waveform, Non-repetitive, one cycle, per diode, T <sub>a</sub> =25°C	8	Α
Junction temperature <sup>(1)</sup>	Tj	-	125	°C
Storage temperature	T <sub>stg</sub>	-	-40 ~ 125	°C

Note(1) To avoid occurrence of thermal runaway, actual board is to be designed to fulfill dP<sub>d</sub>/dT<sub>j</sub><1/R<sub>th(j-a)</sub>.

# ● Characteristics (T<sub>a</sub>=25°C unless otherwise specified)

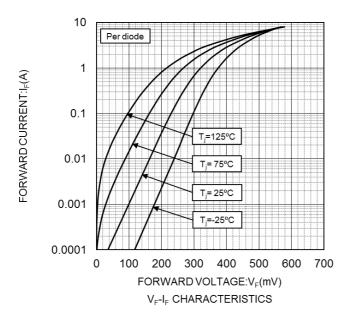
	nor	diod.	_
Value	וסט	uluu	C

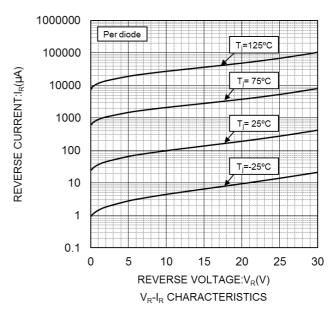
٠ ۵	• • • • • • • • • • • • • • • • • • • •			value per aleae			
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit	
Equipment voltage	V <sub>F1</sub>	I <sub>F</sub> =1A	-	0.30	0.35	V	
Forward voltage	V <sub>F2</sub>	I <sub>F</sub> =2A	-	0.35	0.40	V	
Reverse current	I <sub>R</sub>	V <sub>R</sub> =15V	-	280	900	μA	
Capacitance between terminals	C <sub>t</sub>	V <sub>R</sub> =20V f=1MHz	-	70	-	рF	
Reverse recovery time	t <sub>rr</sub>	I <sub>F</sub> =0.5A I <sub>R</sub> =1A I <sub>rr</sub> =0.25*IR	-	-	20	ns	

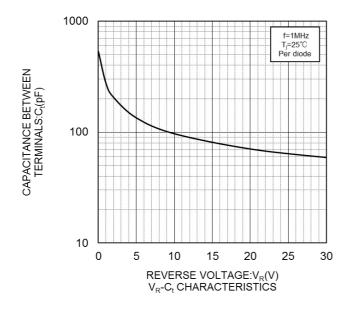
#### Attention

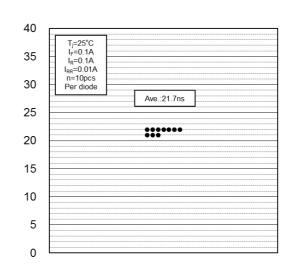
Compared with PN junction diodes, Schottky Barrier Diode is generally high reverse current (IR). The reverse loss of the diode might increase as temperature increasing that causes heat-up and further IR. This phenomenon might end up the thermal destruction(thermal runaway). Therefore please give consideration to the reverse loss and the ambient temperature when using this product.

## Characteristic Curves





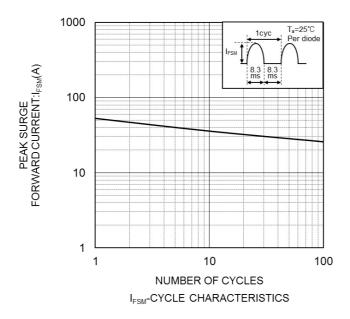


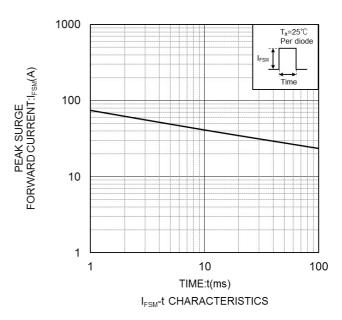


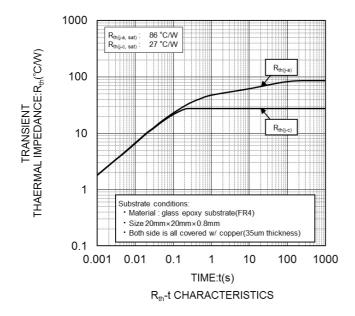
trr DISPERSION MAP

REVERSE RECOVERY TIME:t<sub>rr</sub>(ns)

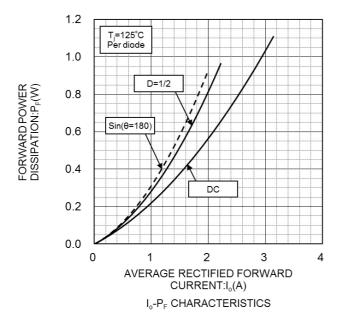
## Characteristic Curves

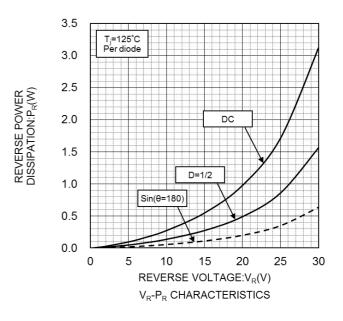


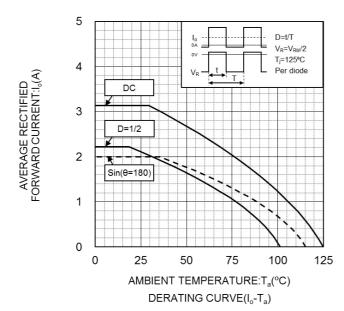


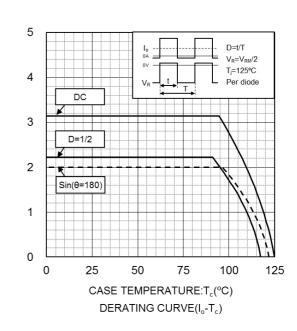


# Characteristic Curves



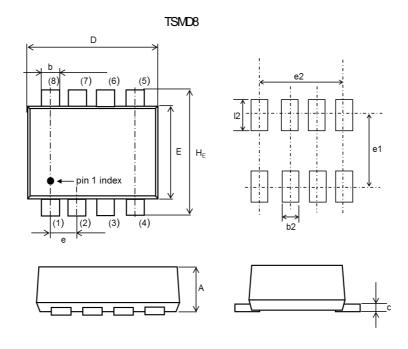






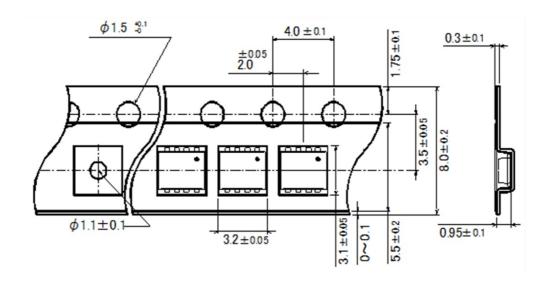
AVERAGE RECTIFIED FORWARD CURRENT:1<sub>o</sub>(A)

# Dimensions



DIM		Milimeters			Inches	
DIIVI	Min. Average		Max.	Min.	Average	Max.
Α	0.75	0.80	0.85	0.030	0.031	0.033
b	0.27	0.32	0.37	0.011	0.013	0.015
С	0.12	0.17	0.22	0.005	0.007	0.009
D	2.90	3.00	3.10	0.114	0.118	0.122
E	2.30	2.40	2.50	0.091	0.094	0.098
H <sub>E</sub>	2.70	2.80	2.90	0.106	0.110	0.114
е	0.55	0.65	0.75	0.022	0.026	0.030
12	-	0.80	-	-	0.031	-
b2	-	0.45	-	-	0.018	-
e1	-	2.40		-	0.094	-
e2	-	1.95	-	-	0.077	-

# ● Taping (Unit:mm)



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(Note1) Medical Equipment Classification of the Specific Applications

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JAPAN	USA	EU	CHINA
CLASSⅢ	CLASSIII	CLASS II b	CL ACCTI
CLASSIV	CLASSIII	CLASSⅢ	CLASSⅢ

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  - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
  - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
  - [f] Sealing or coating our Products with resin or other coating materials
  - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
  - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

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- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

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#### **Precaution for Electrostatic**

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

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- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
  - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
- Even under ROHM recommended storage condition, solderability of products out of recommended storage time period
  may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is
  exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

#### **Precaution for Product Label**

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